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BIOFY® Sensor
Version 1.2

SFH 7072



Features:
- Multi chip package featuring two green emitters, one red emitter, one infrared emitter and two detectors
- Package size: (WxDxH) 7.5 mm x 3.9 mm x 0.9 mm
- Light Barriers to block optical crosstalk
- optimized for strong PPG signal

Applications
- Heart rate monitoring
- Pulse oximetry

for:
- Wearable devices (e.g. smart watches, fitness trackers, ...)
- Mobile devices

Ordering Information

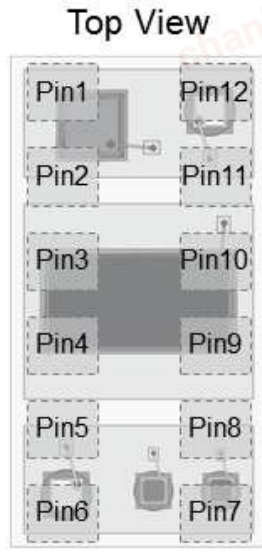
Type	Ordering Code
SFH7072	Q65112A1516

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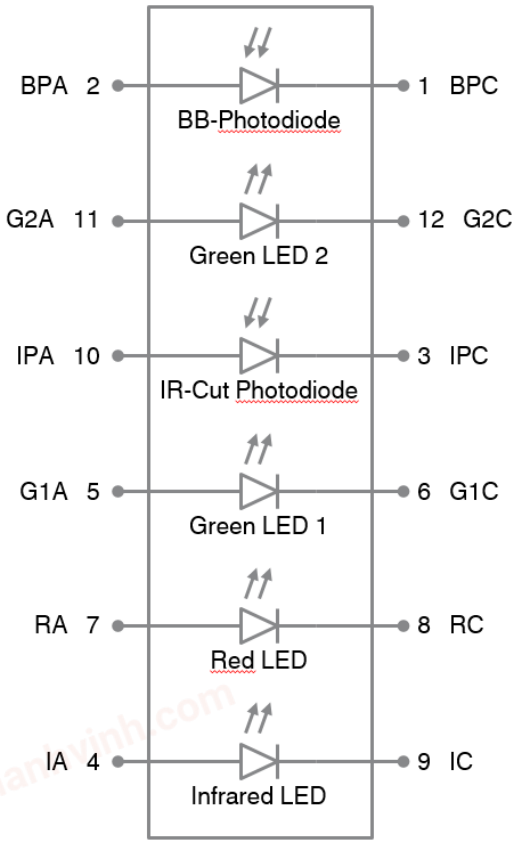
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Pin configuration

Pin	Name	Function
1	BPC	Broadband photodiode cathode
2	BPA	Broadband photodiode anode
3	IPC	IR-Cut photodiode cathode
4	IA	Infrared LED anode
5	G1A	Green LED 1 anode
6	G1C	Green LED 1 cathode
7	RA	Red LED anode
8	RC	Red LED cathode
9	IC	Infrared LED cathode
10	IPA	IR-Cut photodiode anode
11	G2A	Green LED 2 anode
12	G2C	Green LED 2 cathode



Block diagram



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Maximum Ratings (T_A = 25 °C)

Parameter	Symbol	Values	Unit
General			
Operating temperature range	T_{op}	-40 … 85	°C
Storage temperature range	T_{stg}	-40 … 85	°C
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	V_{ESD}	2	kV
Infrared Emitter			
Reverse Voltage	V_R	5	V
Forward current	$I_{F\ (DC)}$	60	mA
Surge current (t_p = 100 µs, D = 0)	I_{FSM}	1	A
Red Emitter			
Reverse voltage	V_R	12	V
Forward current	$I_{F\ (DC)}$	40	mA
Surge current (t_p = 100 µs, D = 0)	I_{FSM}	600	mA
Green Emitters			
Reverse voltage	V_R	5	V
Forward current	$I_{F\ (DC)}$	25	mA
Surge current (t_p = 10 µs, D = 0)	I_{FSM}	300	mA
Detectors			
Reverse voltage	V_R	16	V

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Characteristics (T_A = 25 °C)

Parameter		Symbol	Value	Unit
Infrared Emitter				
Wavelength of peak emission (I_F = 20 mA, t_p = 20 ms)	(typ.)	λ_{peak}	950	nm
Centroid Wavelength (I_F = 20 mA, t_p = 20 ms)	(typ. (max.))	$\lambda_{centroid}$	940 (±10)	nm
Spectral bandwidth at 50% of I_{max} (I_F = 20 mA, t_p = 20 ms)	(typ.)	$\Delta\lambda$	42	nm
Half angle	(typ.)	φ	± 60	°
Rise and fall time of I_e (10% and 90% of $I_{e\ max}$) (I_F = 100 mA, t_p = 16 µs, R_L = 50 Ω)	(typ.)	t_r, t_f	16	ns
Forward voltage (I_F = 20 mA, t_p = 20 ms)	(typ. (max.))	V_F	1.3 (≤ 1.8)	V
Reverse current (V_R = 5 V)		I_R	not designed for reverse operation	µA
Radiant intensity (I_F = 20 mA, t_p = 20 ms)	(typ.)	I_e	3.9	mW / sr
Total radiant flux (I_F = 20 mA, t_p = 20 ms)	(typ.)	Φ_e	11	mW
Temperature coefficient of I_e or Φ_e (I_F = 20 mA, t_p = 20 ms)	(typ.)	TC_I	-0.3	% / K
Temperature coefficient of V_F (I_F = 20 mA, t_p = 20 ms)	(typ.)	TC_V	-0.8	mV / K
Temperature coefficient of $\lambda_{centroid}$ (I_F = 20 mA, t_p = 20 ms)	(typ.)	$TC_{\lambda centroid}$	0.25	nm / K

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Characteristics (T_A = 25 °C)

Parameter		Symbol	Value	Unit
Red Emitter				
Wavelength of peak emission (I_F = 20 mA)	(typ.)	λ_{peak}	660	nm
Centroid Wavelength (I_F = 20 mA)	(typ. (max.))	$\lambda_{centroid}$	655 (±3)	nm
Spectral bandwidth at 50% of I_{max} (I_F = 20 mA)	(typ.)	$\Delta\lambda$	17	nm
Half angle	(typ.)	φ	± 60	°
Rise and fall time of I_e (10% and 90% of $I_{e\ max}$) (I_F = 100 mA, t_p = 16 µs, R_L = 50 Ω)	(typ.)	t_r, t_f	17	ns
Forward voltage (I_F = 20 mA)	(typ. (max.))	V_F	2.1 (≤ 2.8)	V
Reverse current (V_R = 12V)		I_R	not designed for reverse operation	µA
Radiant intensity (I_F = 20 mA, t_p = 20 ms)	(typ.)	I_e	4.8	mW / sr
Total radiant flux (I_F = 20 mA, t_p = 20 ms)	(typ.)	Φ_e	14	mW
Temperature coefficient of $\lambda_{centroid}$ (I_F = 20 mA, -10°C ≤ T ≤ 100°C)	(typ.)	$TC_{\lambda centroid}$	0.13	nm / K

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Characteristics (T_A = 25 °C)

Parameter		Symbol	Value	Unit
Green Emitter (single emitter)				
Wavelength of peak emission (I_F = 20 mA)	(typ.)	λ_{peak}	526	nm
Centroid Wavelength (I_F = 20 mA)	(typ. (max.))	$\lambda_{centroid}$	530 (±10)	nm
Spectral bandwidth at 50% of I_{max} (I_F = 20 mA)	(typ.)	$\Delta\lambda$	32	nm
Half angle	(typ.)	φ	± 60	°
Rise and fall time of I_e (10% and 90% of $I_{e\ max}$) (I_F = 100 mA, t_p = 16 µs, R_L = 50 Ω)	(typ.)	t_r, t_f	56	ns
Forward voltage (I_F = 20 mA)	(typ. (max.))	V_F	3.0 (≤ 3.4)	V
Reverse current (V_R = 5 V)		I_R	not designed for reverse operation	µA
Radiant intensity (I_F = 20 mA, t_p = 20 ms)	(typ.)	I_e	3.8	mW / sr
Total radiant flux (I_F = 20 mA, t_p = 20 ms)	(typ.)	Φ_e	11	mW
Temperature coefficient of I_e or Φ_e (I_F = 20 mA, t_p = 20 ms)	(typ.)	TC_I	-0.35	% / K
Temperature coefficient of $\lambda_{centroid}$ (I_F = 20 mA, -10°C ≤ T ≤ 100°C)	(typ.)	$TC_{\lambda centroid}$	0.03	nm / K
Temperature coefficient of V_F (I_F = 20 mA, -10°C ≤ T ≤ 100°C)	(typ.)	TC_V	-3.6	mV / K

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Characteristics (T_A = 25 °C)

Parameter		Symbol	Value	Unit
IR-Cut Detector				
Photocurrent (E_e = 0.1 mW/cm², λ = 530 nm, V_R = 5 V)	(typ.)	$I_{P,530}$	1.1	µA
Wavelength of max. sensitivity	(typ.)	$\lambda_{S\ max}$	635	nm
Spectral range of sensitivity	(typ.)	$\lambda_{10\%}$	402 … 694	nm
Radiation sensitive area	(typ.)	A	3.46	mm²
Dimensions of radiant sensitive area	(typ.)	L x W	1.29 x 2.69	mm x mm
Half angle	(typ.)	φ	± 57	°
Dark current (V_R = 5 V, Ee = 0 mW/cm²)	(typ. (max.))	I_R	0.4 (≤ 2)	nA
Spectral sensitivity of the chip (λ = 530nm)	(typ.)	$S_{\lambda 530}$	0.31	A / W
Spectral sensitivity of the chip (λ > 690nm)	(typ.)	S_{IR}	0.02	A / W
Open-circuit voltage (E_e = 0.1 mW/cm², λ = 530 nm)	(typ.)	$V_{O,530}$	390	mV
Short-circuit current (E_e = 0.1 mW/cm², λ = 530 nm)	(typ.)	$I_{SC,530}$	1.1	µA
Rise and fall time (V_R = 5 V, R_L = 50 Ω, λ = 530nm)	(typ.)	t_r, t_f	40	ns
Forward voltage (I_F = 10 mA, E = 0 mW/cm²)	(typ.)	V_F	0.84	V
Capacitance (V_R = 5 V, f = 1 MHz, E = 0 mW/cm²)	(typ.)	C_0	55	pF

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Characteristics (T_A = 25 °C)

Parameter		Symbol	Value	Unit
Broadband Detector				
Photocurrent (E_e = 0.1 mW/cm², λ = 530nm, V_R = 5 V)	(typ.)	$I_{P,530}$	0.4	µA
Photocurrent (E_e = 0.1 mW/cm², λ = 655 nm, V_R = 5 V)	(typ.)	$I_{P,655}$	0.6	µA
Photocurrent (E_e = 0.1 mW/cm², λ = 940 nm, V_R = 5 V)	(typ.)	$I_{P,940}$	1.1	µA
Wavelength of max. sensitivity	(typ.)	$\lambda_{S\ max}$	960	nm
Spectral range of sensitivity	(typ.)	$\lambda_{10\%}$	410 … 1100	nm
Radiation sensitive area	(typ.)	A	0.88	mm²
Dimensions of radiant sensitive area	(typ.)	L x W	0.89 x 0.89	mm x mm
Half angle	(typ.)	φ	± 60	°
Dark current (V_R = 5 V, Ee = 0 mW/cm²)	(typ. (max.))	I_R	0.05 (≤ 10)	nA
Spectral sensitivity of the chip (λ = 530 nm)	(typ.)	$S_{\lambda 530}$	0.31	A / W
Spectral sensitivity of the chip (λ = 655nm)	(typ.)	$S_{\lambda 655}$	0.56	A / W
Spectral sensitivity of the chip (λ = 940 nm)	(typ.)	$S_{\lambda 940}$	0.84	A / W
Open-circuit voltage (E_e = 0.1 mW/cm², λ = 530 nm)	(typ.)	$V_{O,530}$	211	mV
Short-circuit current (E_e = 0.1 mW/cm², λ = 530 nm)	(typ.)	$I_{SC,530}$	0.4	µA
Open-circuit voltage (E_e = 0.1 mW/cm², λ = 655nm)	(typ.)	$V_{O,655}$	249	mV
Short-circuit current (E_e = 0.1 mW/cm², λ = 655 nm)	(typ.)	$I_{SC,655}$	0.6	µA
Open-circuit voltage (E_e = 0.1 mW/cm², λ =940 nm)	(typ.)	$V_{O,940}$	266	mV
Short-circuit current (E_e = 0.1 mW/cm², λ = 940 nm)	(typ.)	$I_{SC,940}$	1.1	µA

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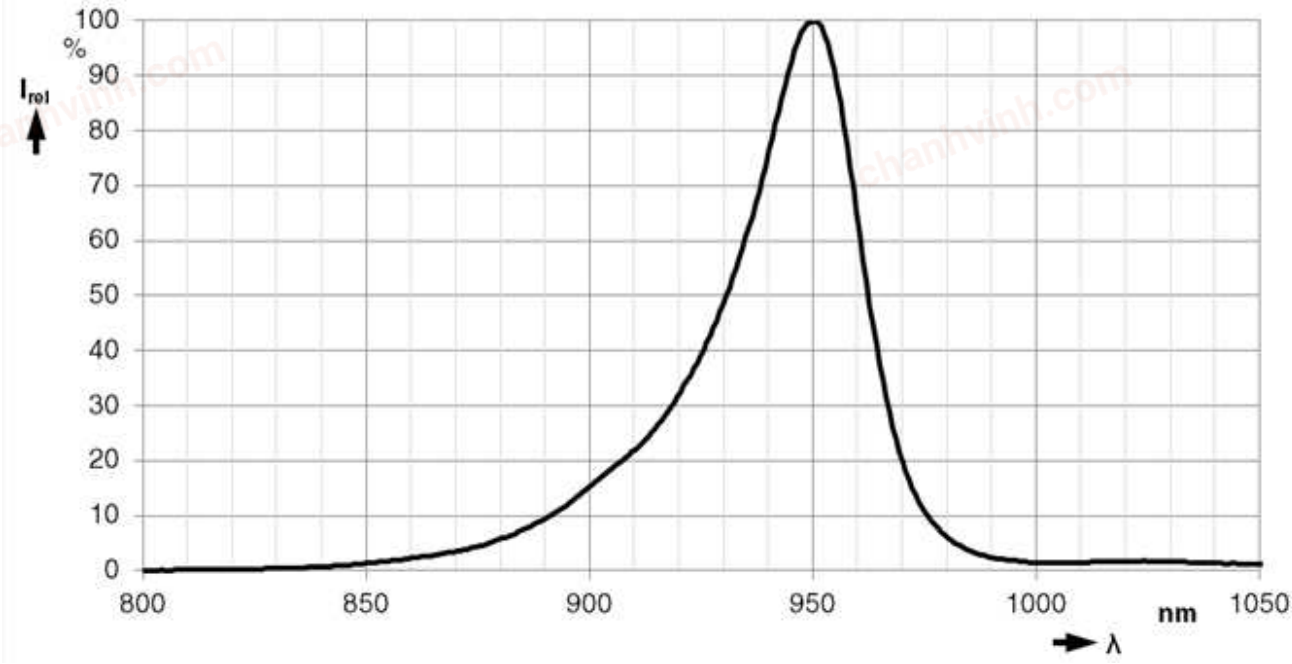
Characteristics (T_A = 25 °C)

Parameter		Symbol	Value	Unit
Rise and fall time (V_R = 5V, R_L = 50 Ω, λ = 940 nm)	(typ.)	t_r, t_f	0.75	µs
Forward voltage (I_F = 100 mA, E = 0 mW/cm²)	(typ.)	V_F	1.16	V
Capacitance (V_R = 5 V, f = 1 MHz, E = 0 mW/cm²)	(typ.)	C_0	4.2	pF

Diagrams for infrared emitter

Relative spectral emission [1)]

$I_{rel} = f(\lambda)$, T_A = 25 °C, I_F = 20 mA



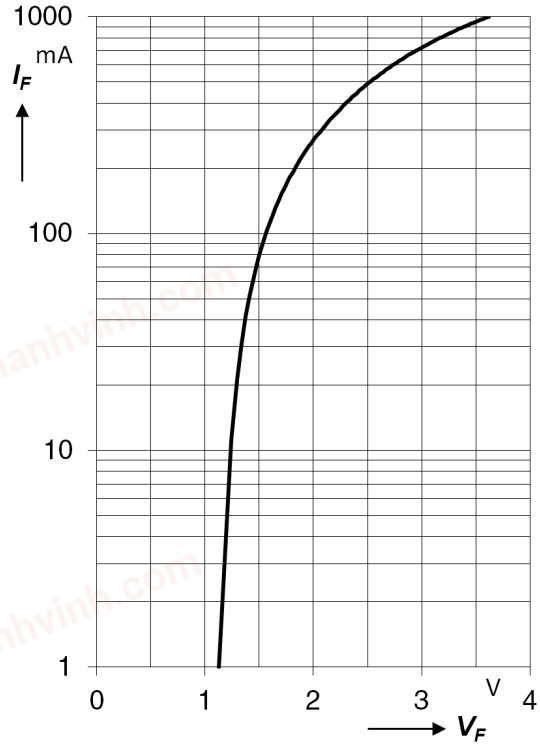
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Diagrams for infrared emitter

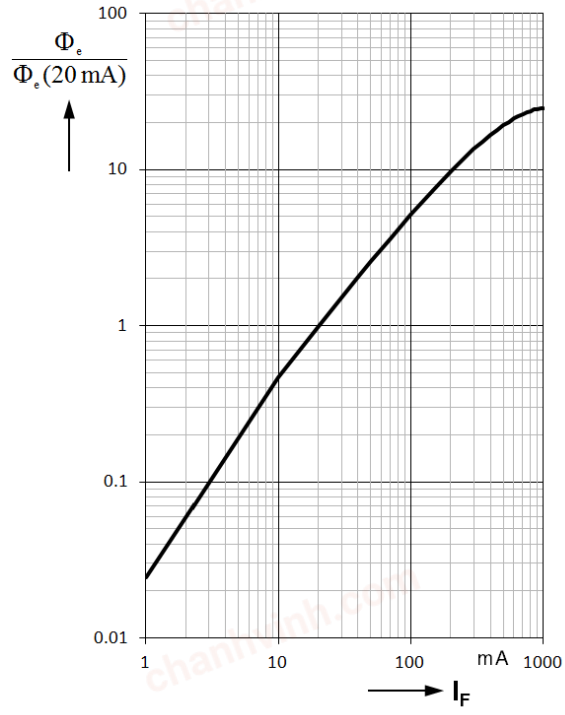
Forward current [1)]

$I_F = f(V_F)$, single pulse, $t_p = 100\ \mu s$, $T_A = 25°C$



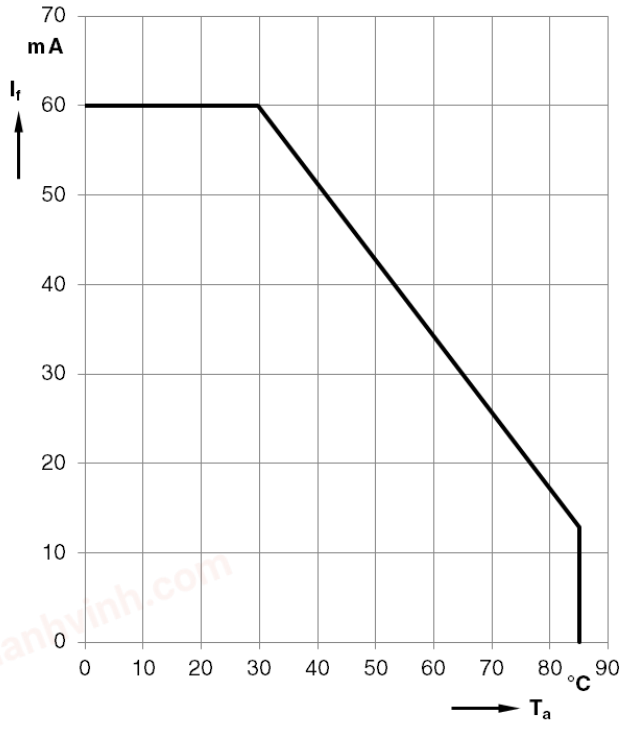
Relative radiant flux [1)]

$\Phi_e / \Phi_e(20\ mA) = f(I_F)$, single pulse, $t_p = 25\mu s$, $T_A = 25°C$



Max. permissible forward current [1)]

$I_{F,max} = f(T_A)$, $R_{thJA} = 800$ K/W



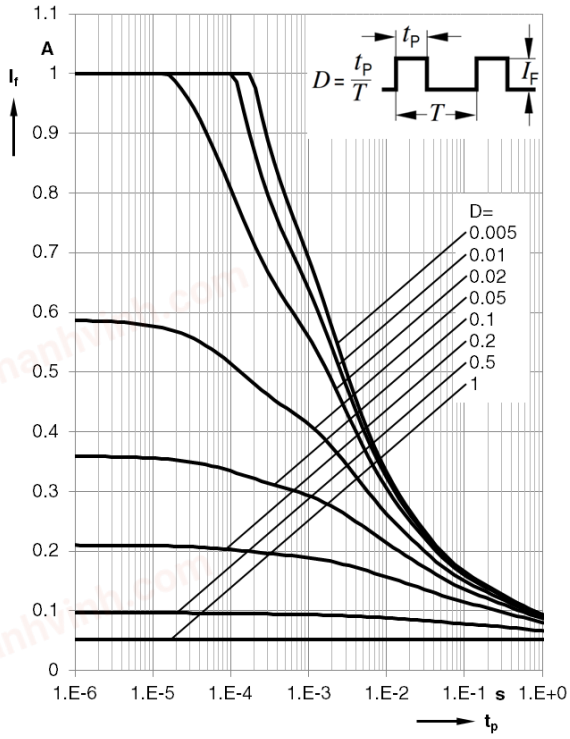
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Diagrams for infrared emitter

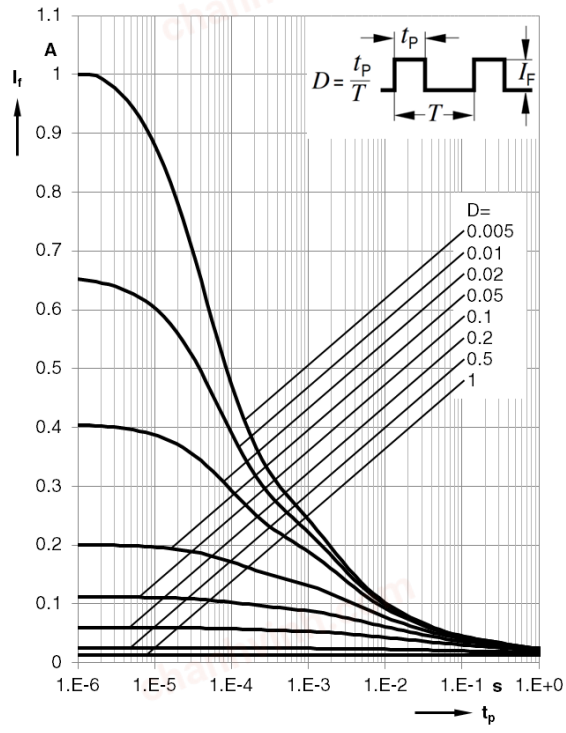
Permissible pulse handling capability [1)]

$I_F = f(t_p)$, T_A= 40°C, duty cycle D = parameter



Permissible pulse handling capability [1)]

$I_F = f(t_p)$, T_A= 85°C, duty cycle D = parameter



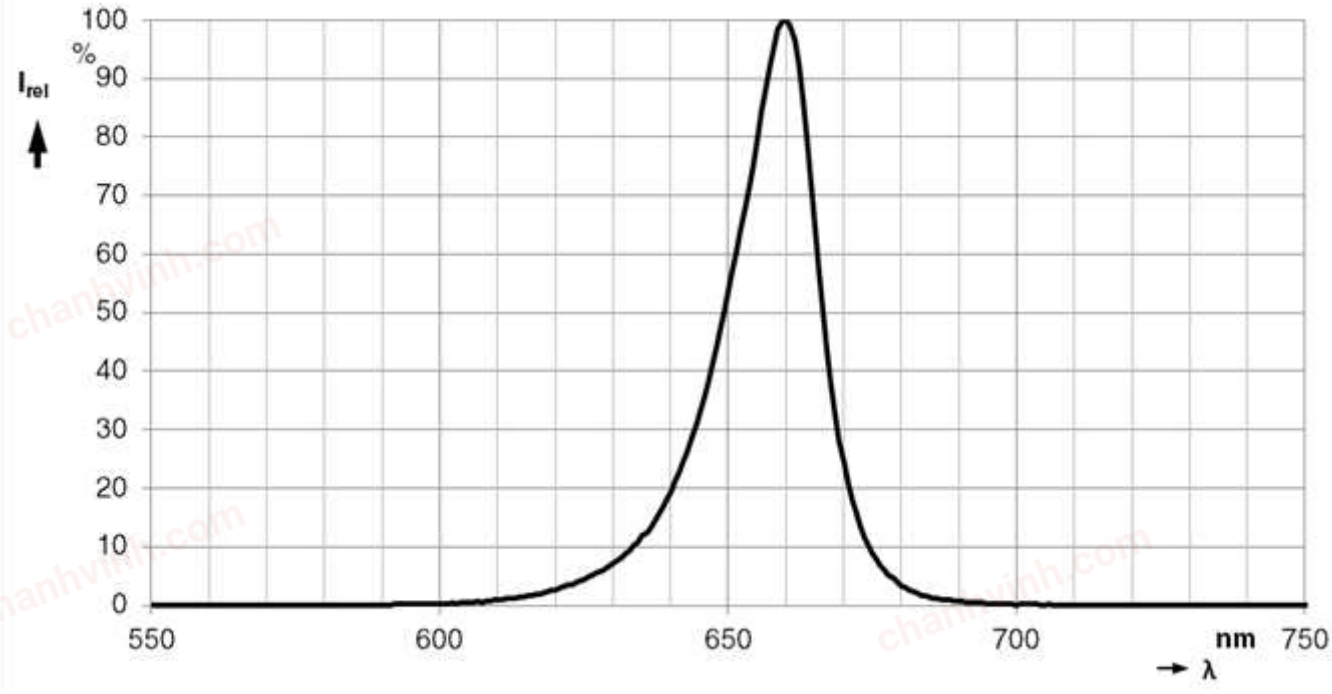
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Diagrams for red emitter

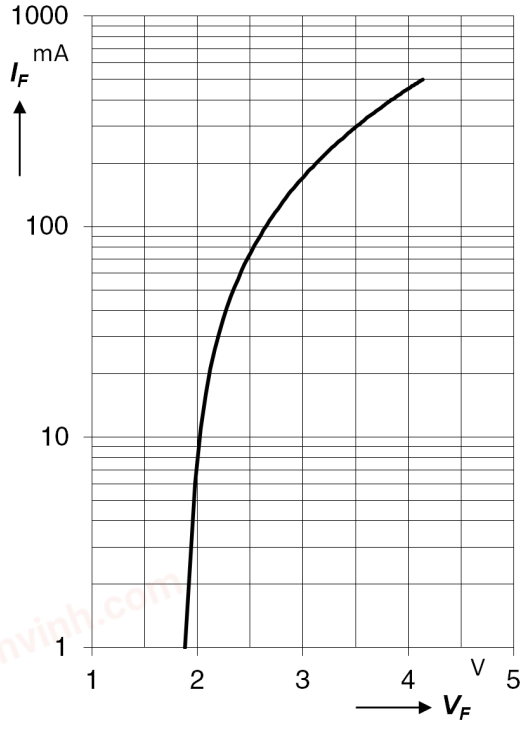
Relative spectral emission [1)]

$I_{rel} = f(\lambda)$, $T_A = 25$ °C, $I_F = 20$ mA



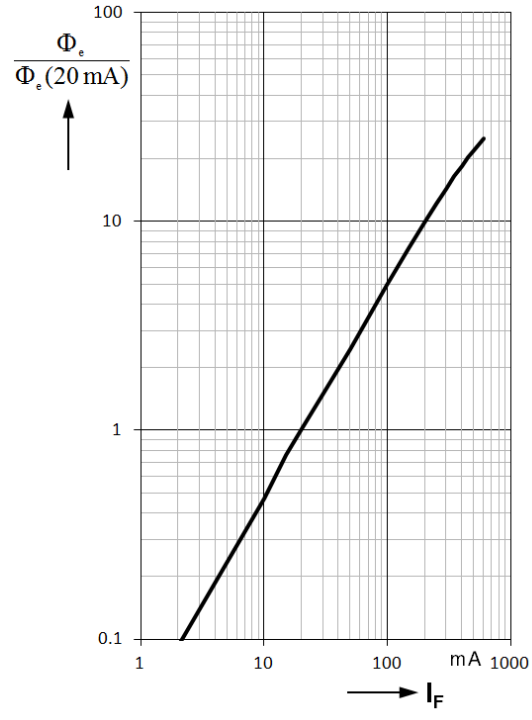
Forward current [1)]

$I_F = f(V_F)$, $T_A = 25$°C



Relative radiant flux [1)]

$\Phi_e / \Phi_e(20\text{ mA}) = f(I_F)$, single pulse, $t_p = 25\mu s$, $T_A = 25$°C



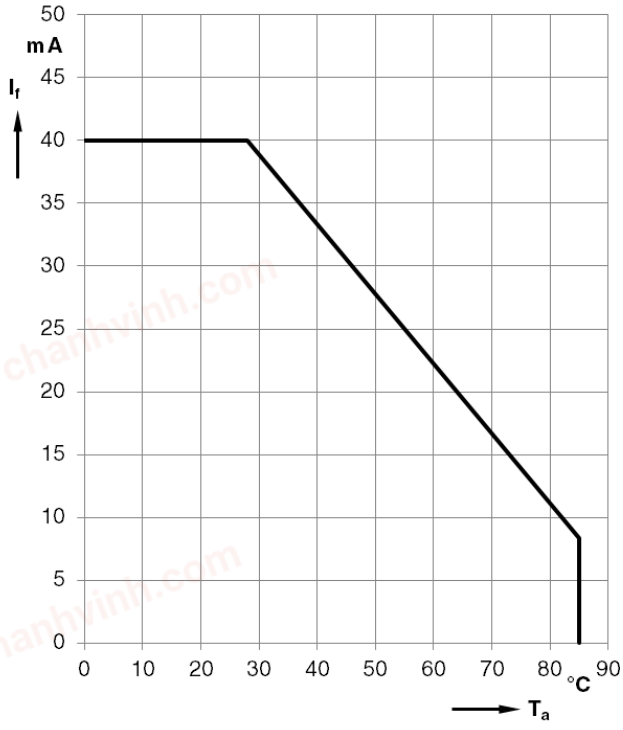
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Diagrams for red emitter

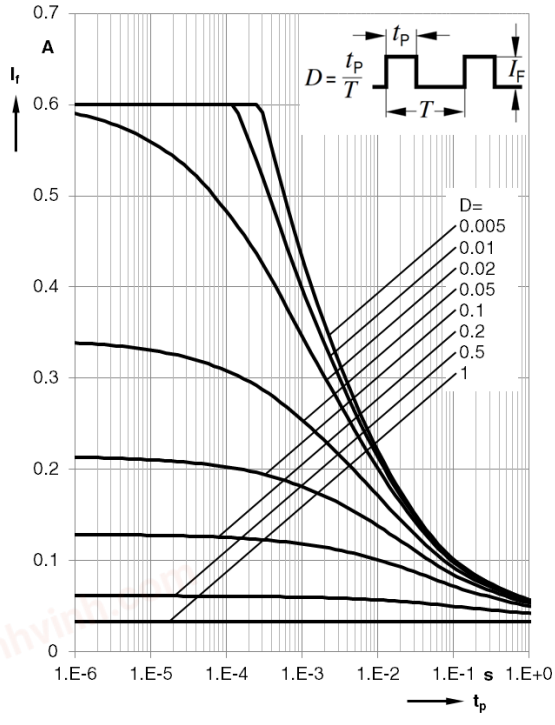
Max. permissible forward current [1)]

$I_{F,max} = f(T_A)$, R_{thJA} = 800 K/W



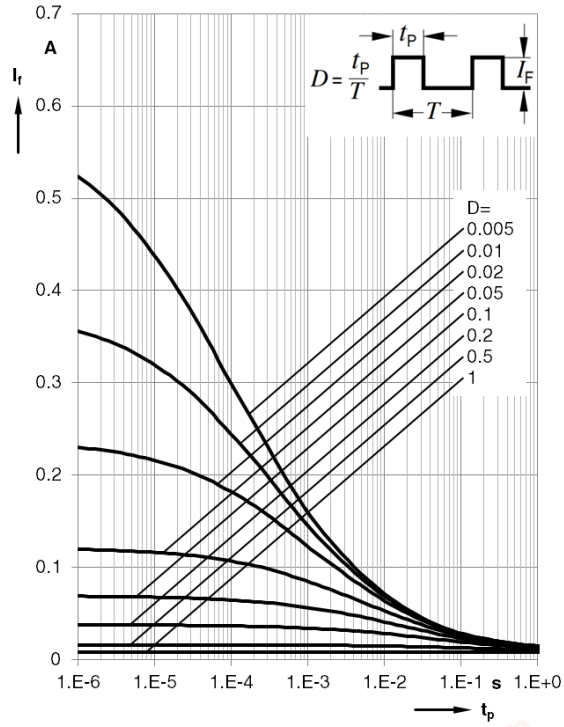
Permissible pulse handling capability [1)]

$I_F = f(t_p)$, T_A= 40°C, duty cycle D = parameter



Permissible pulse handling capability [1)]

$I_F = f(t_p)$, T_A= 85°C, duty cycle D = parameter



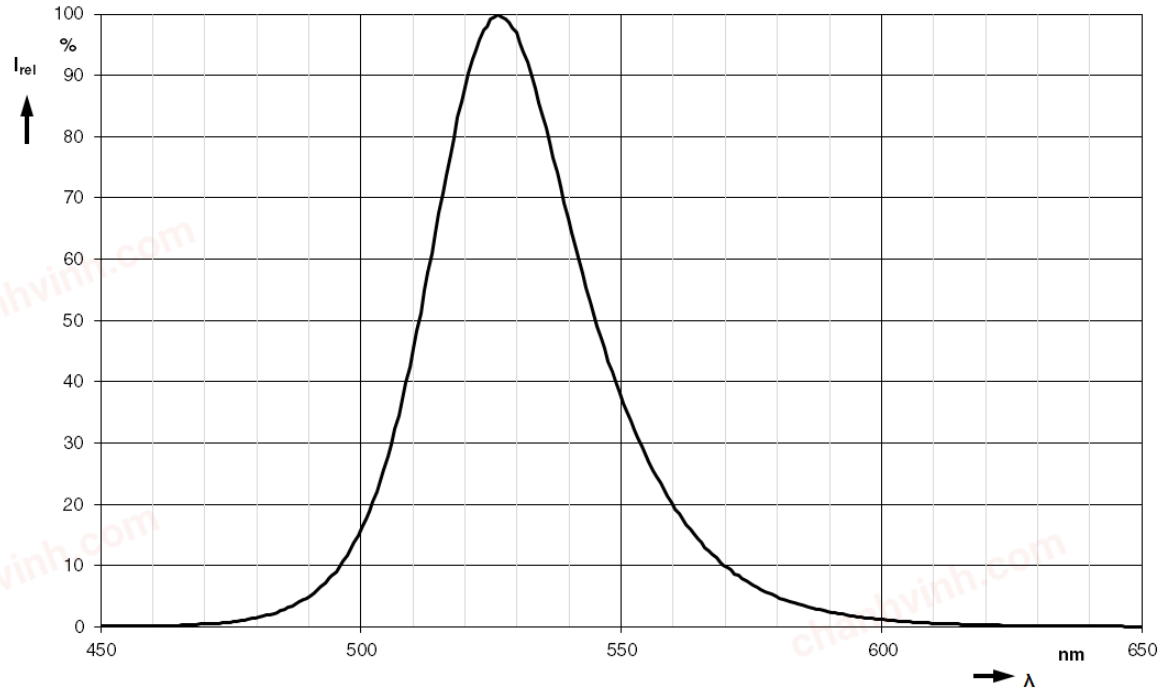
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Diagrams for green emitters

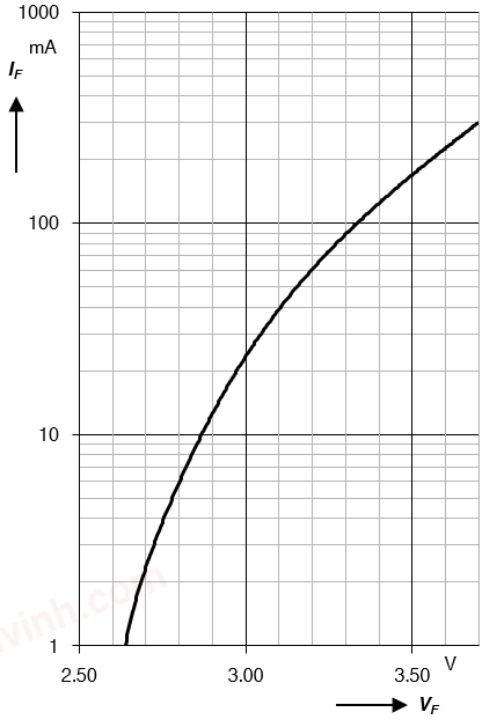
Relative spectral emission [1)]

$I_{rel} = f(\lambda)$, $T_A = 25$ °C, $I_F = 20$ mA



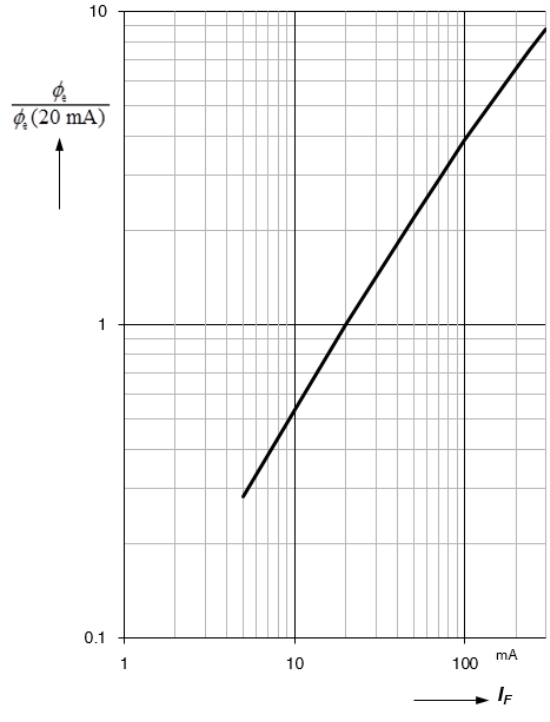
Forward current [1)]

$I_F = f(V_F)$, $T_A = 25$°C



Relative radiant flux [1)]

$\Phi_e / \Phi_e(20\ mA) = f(I_F)$, single pulse, $t_p = 25\mu s$, $T_A = 25$°C



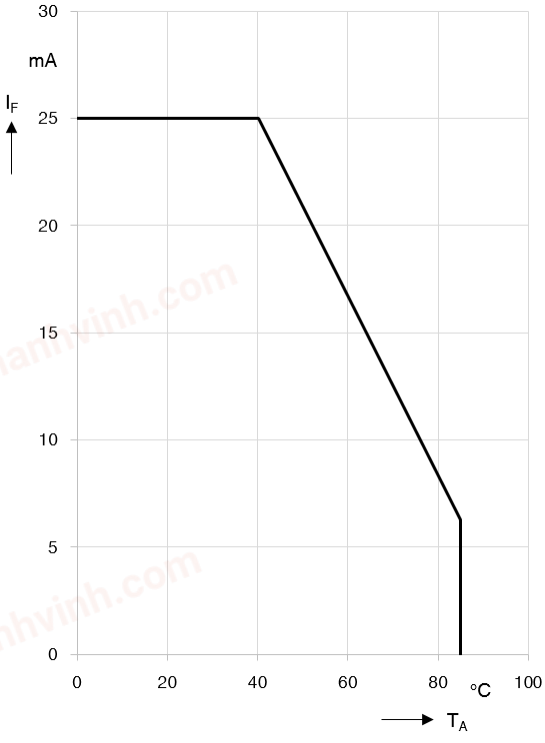
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Diagrams for green emitters

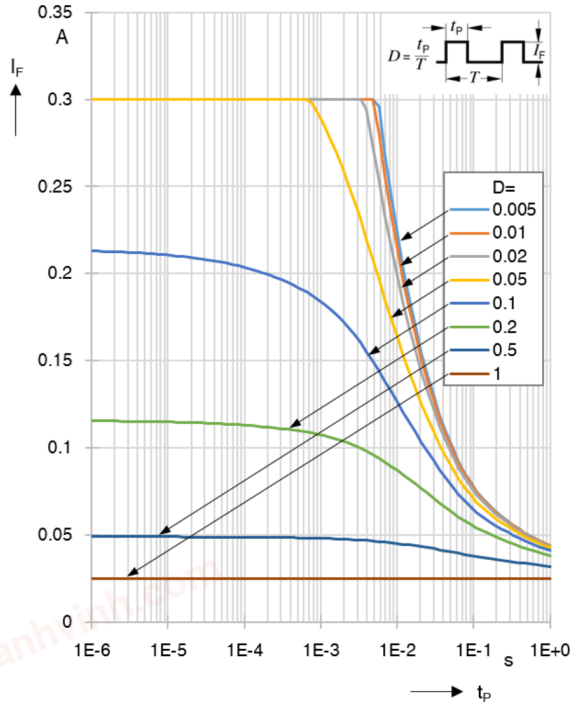
Max. permissible forward current [1)]

$I_{F,max} = f(T_A)$, R_{thJA} = 800 K/W



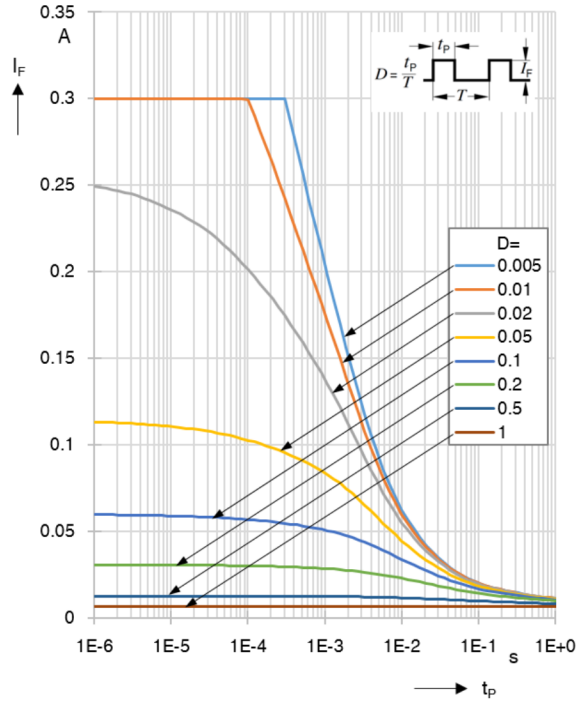
Permissible pulse handling capability [1)]

$I_F = f(t_p)$, T_A= 40°C, duty cycle D



Permissible pulse handling capability [1)]

$I_F = f(t_p)$, T_A= 85°C, duty cycle D



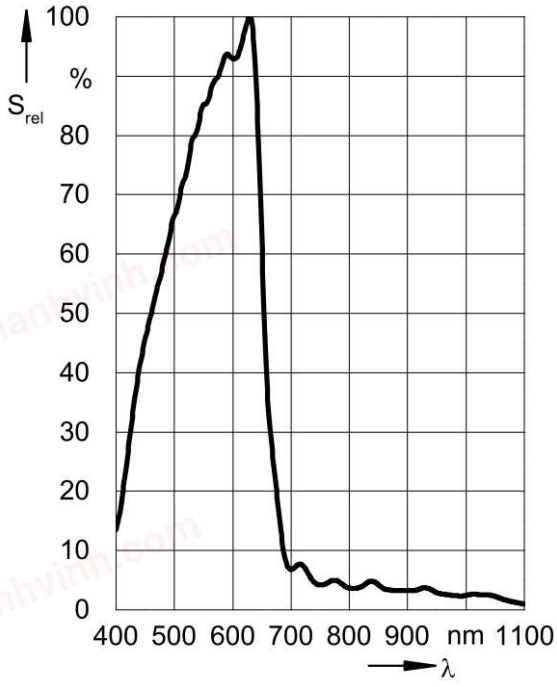
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Diagrams for IR-Cut detector

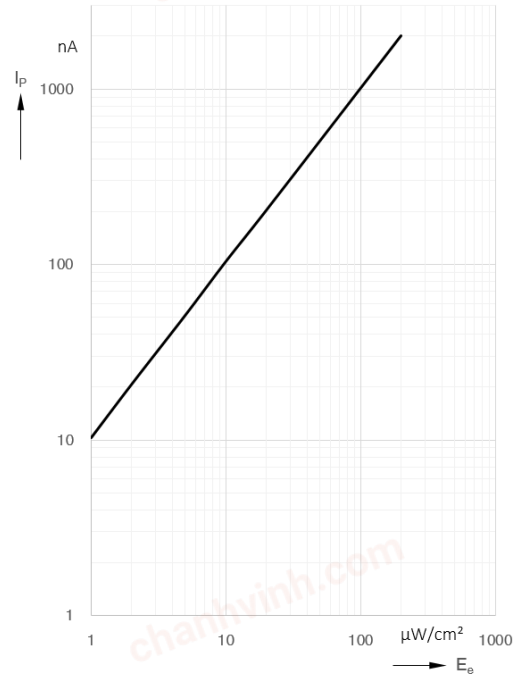
Relative spectral sensitivity [1)]

$S_{rel} = f(\lambda)$, $T_A = 25$ °C



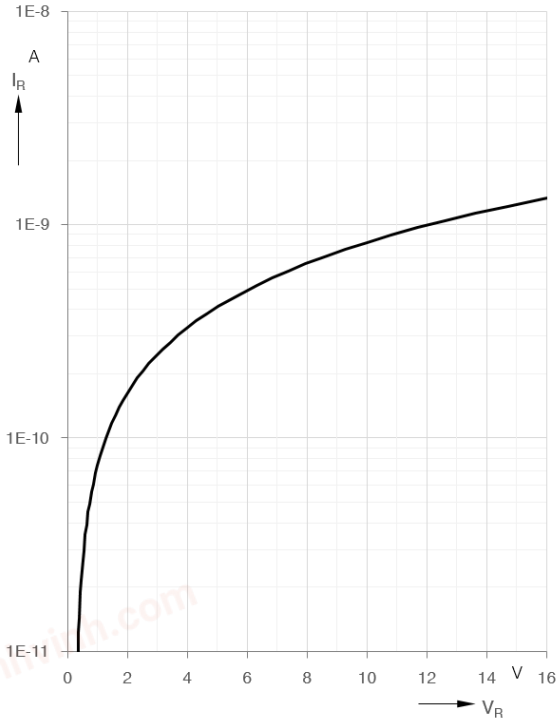
Photocurrent [1)]

$I_P(V_R = 5\ V)$, λ=530nm, $T_A = 25$ °C



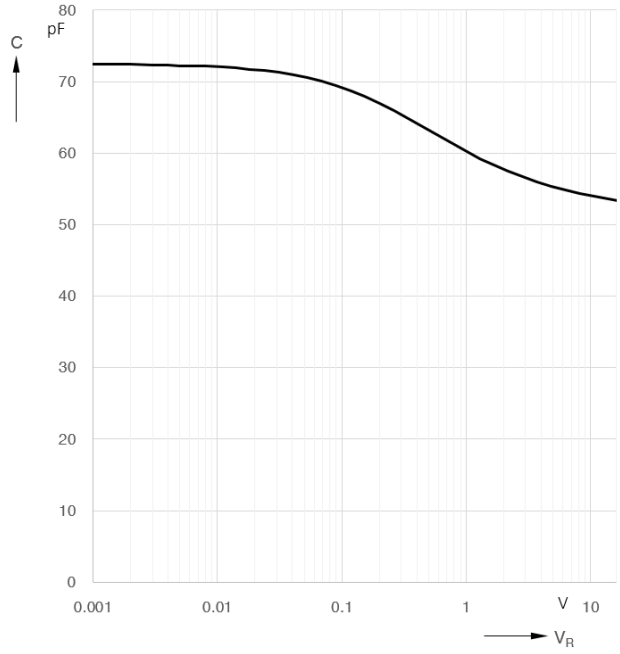
Dark current [1)]

$I_R = f(V_R)$, E = 0 mW/cm², $T_A = 25$ °C



Capacitance [1)]

$C = f(V_R)$, f = 1 MHz, E = 0 mW/cm², $T_A = 25$ °C



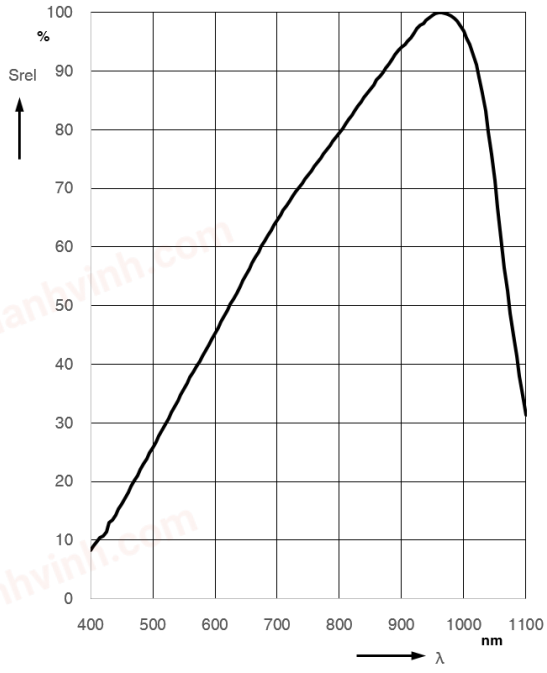
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Diagrams for broadband detector

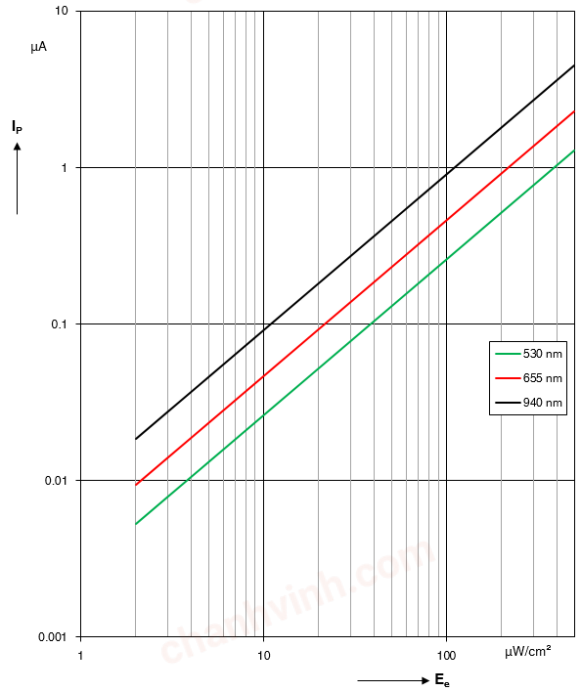
Relative spectral sensitivity [1)]

$S_{rel} = f(\lambda)$, $T_A = 25$ °C



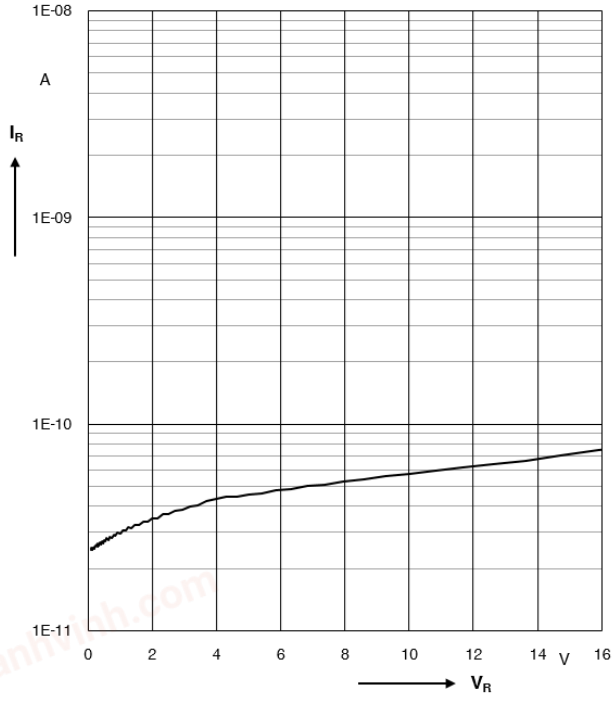
Photocurrent [1)]

$I_P(V_R = 5\ V)$, λ=530, 655nm, 940nm, $T_A = 25$ °C



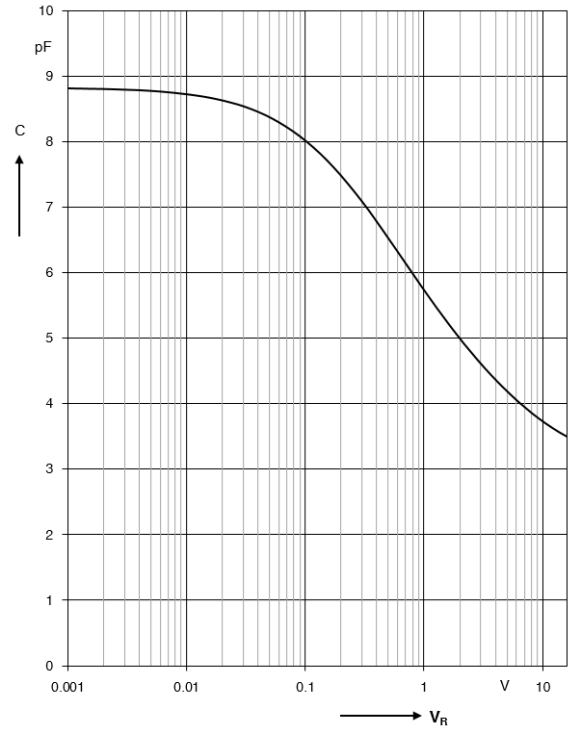
Dark current [1)]

$I_R = f(V_R)$, E = 0 mW/cm², $T_A = 25$ °C



Capacitance [1)]

$C = f(V_R)$, f = 1 MHz, E = 0 mW/cm², $T_A = 25$ °C

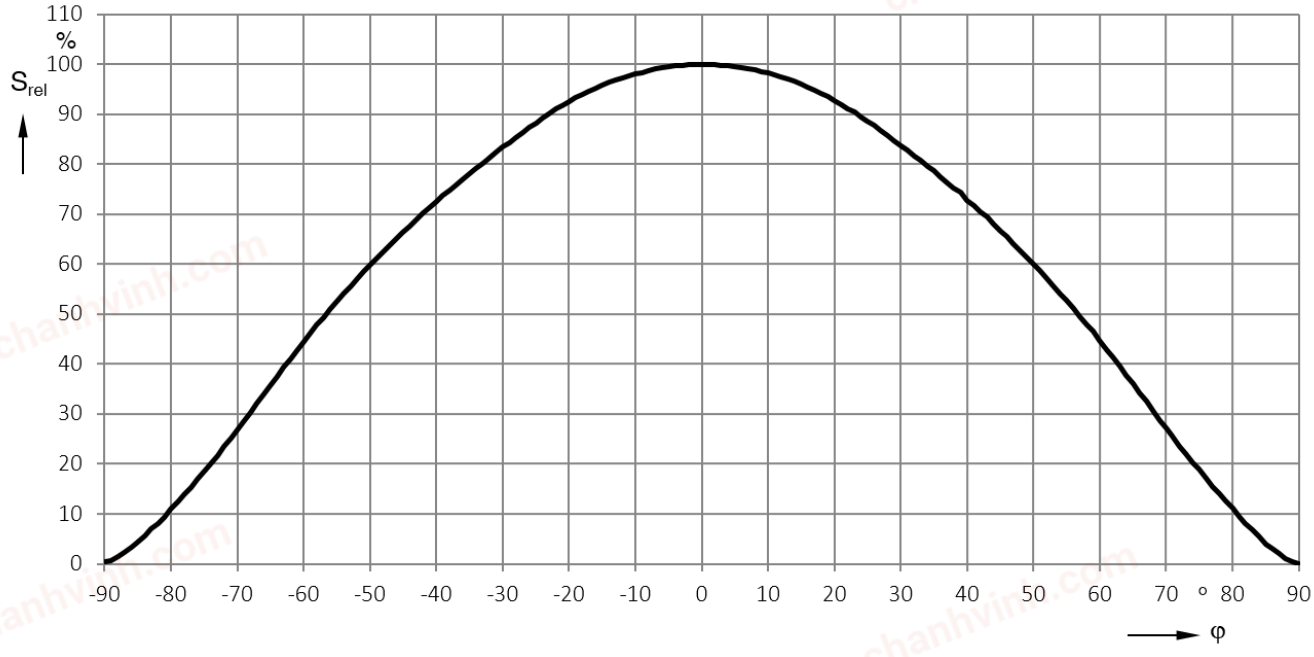


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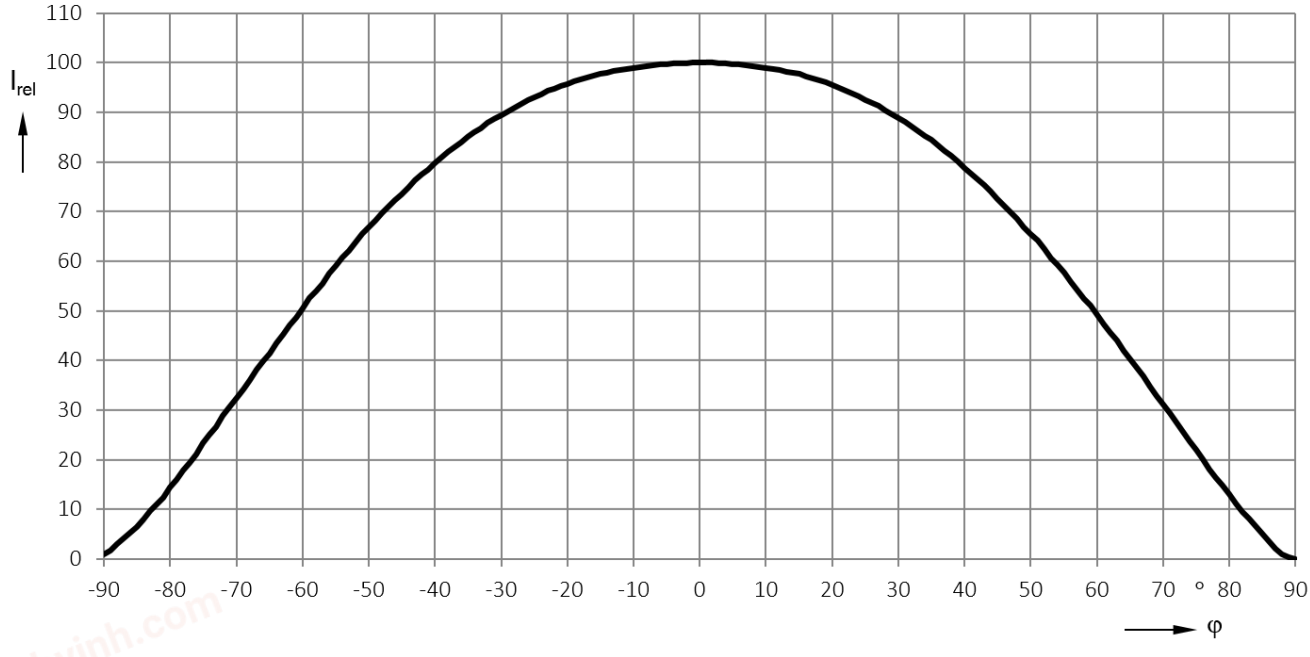
Directional characteristics of detectors [1)]

$S_{rel} = f(j)$, l=530nm



Radiation characteristics of emitters [1)]

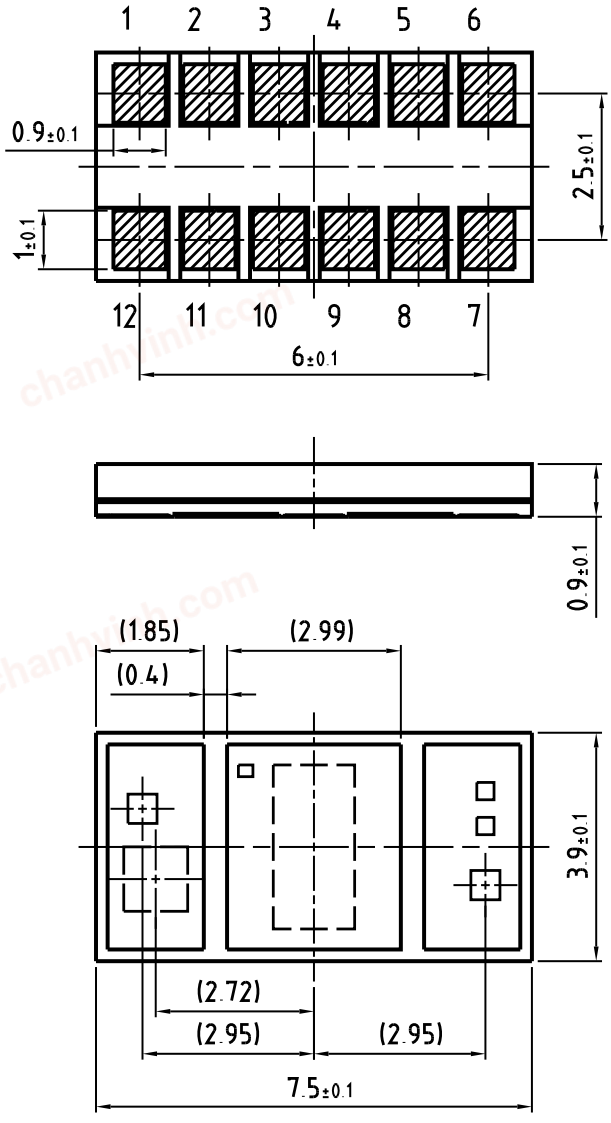
$I_{rel} = f(j)$



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Package Outline



Pin	Name	Function
1	BPC	Broadband photodiode cathode
2	BPA	Broadband photodiode anode
3	IPC	IR-Cut photodiode cathode
4	IA	Infrared LED anode
5	G1A	Green LED 1 anode
6	G1C	Green LED 1 cathode
7	RA	Red LED anode
8	RC	Red LED cathode
9	IC	Infrared LED cathode
10	IPA	IR-Cut photodiode anode
11	G2A	Green LED 2 anode
12	G2C	Green LED 2 cathode

C63062-A4325-A1-01

Dimensions in mm

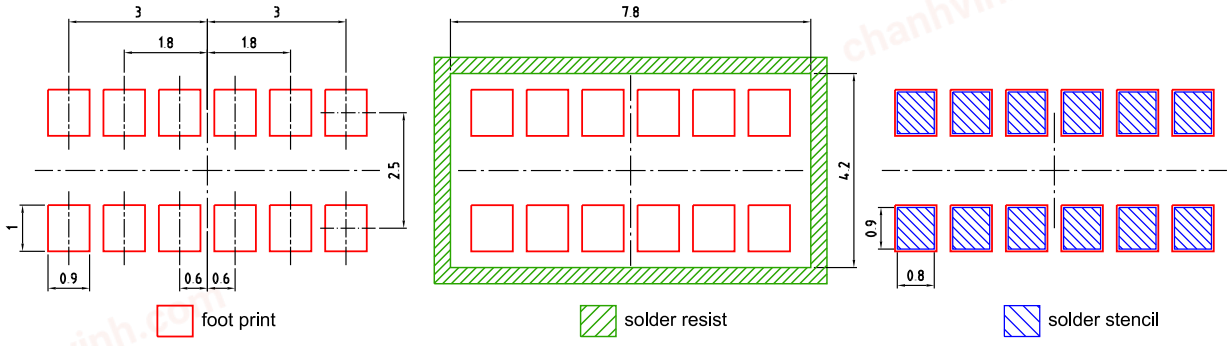
Package:
chip on board

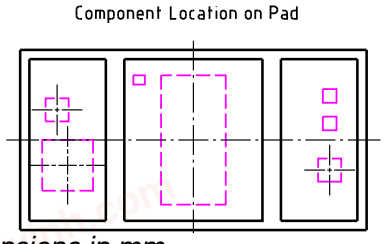
Approximate Weight:
44 mg

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Recommended solder pad design



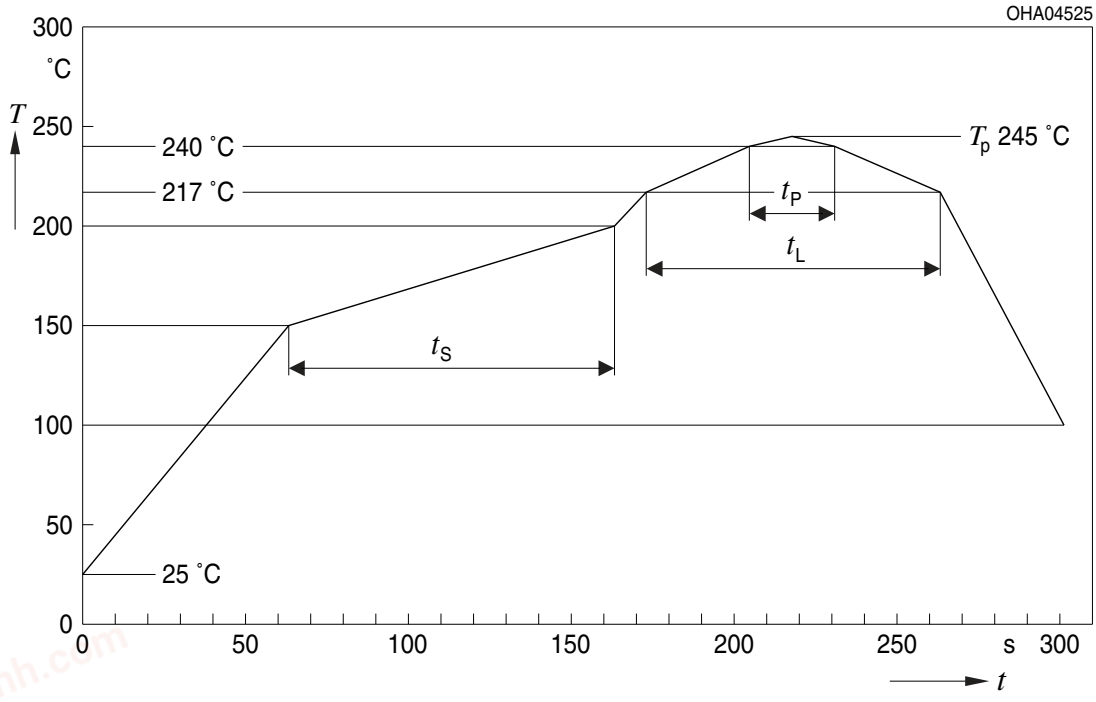


E062.3010.217-01

Dimensions in mm.

Reflow Soldering Profile

Product complies to MSL Level 4 acc. to JEDEC J-STD-020D.01



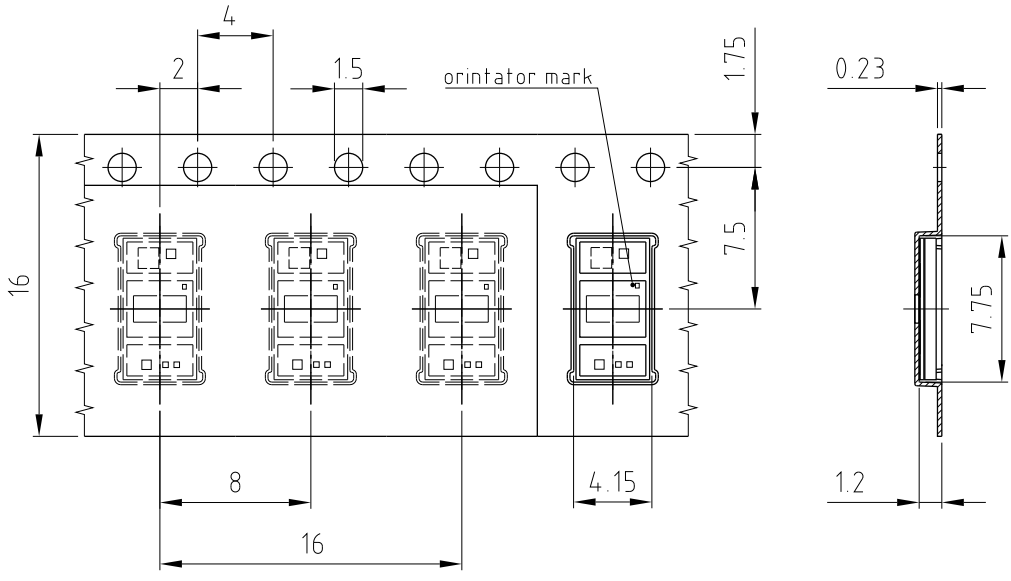
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OH

Profil-Charakteristik Profile Feature	Symbol Symbol	Pb-Free (SnAgCu) Assembly			Einh Unit
		Minimum	Recommendation	Maximum	
Ramp-up Rate to Preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up Rate to Peak*) T_{Smax} to T_P			2	3	K/s
Liquidus Temperature	T_L		217		°C
Time above Liquidus temperature	t_L		80	100	s
Peak Temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down Rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

Method of Taping



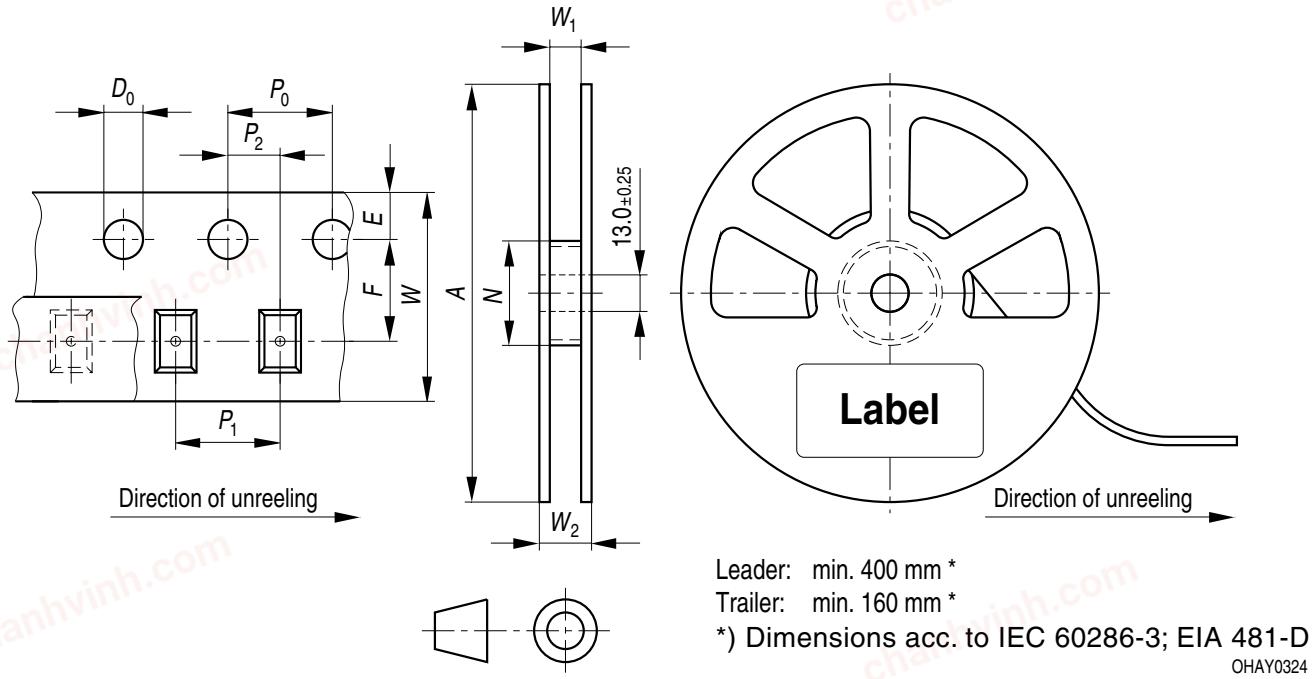
Dimensions in mm.

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Tape and Reel

16 mm tape with 1500 pcs. on Ø 180 mm reel



Leader: min. 400 mm *
Trailer: min. 160 mm *
*) Dimensions acc. to IEC 60286-3; EIA 481-D

OHAY0324

Dimensions in mm

Tape Dimensions [mm]

W	P_0	P_1	P_2	D_0	E	F
16 +0.3 / -0.1	4 ±0.1	8 ±0.1	2 ±0.05	1.5 ±0.1	1.75 ±0.1	7.5 ±0.05

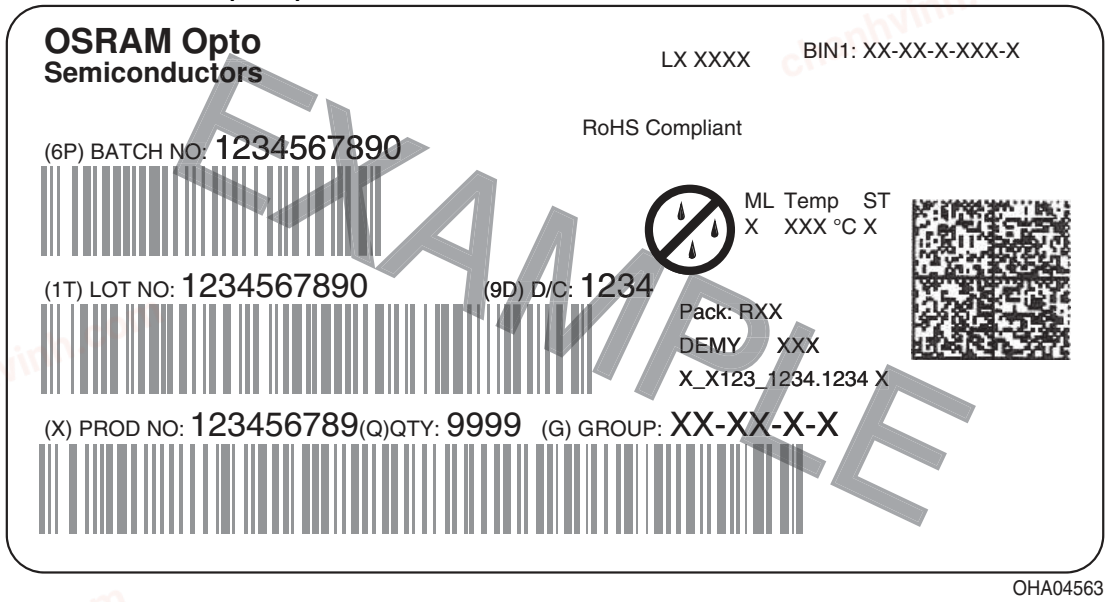
Reel Dimensions [mm]

A	W	N_{min}	W_1	W_{2max}
180	16	60	16.4 +2	22.4

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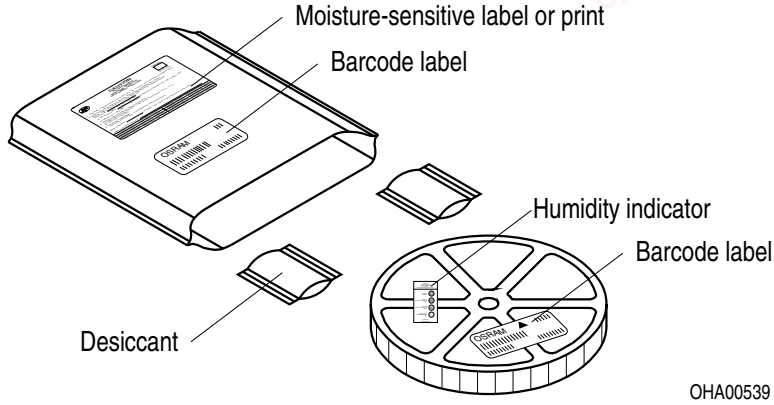
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Barcode-Product-Label (BPL)



OHA04563

Dry Packing Process and Materials



OHA00539

Note:
Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card. Regarding dry pack you will find further information in the internet. Here you will also find the normative references like JEDEC.

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Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

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Glossary

[1] **Typical Values:** Due to the special conditions of the manufacturing processes of LED and photodiodes, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

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